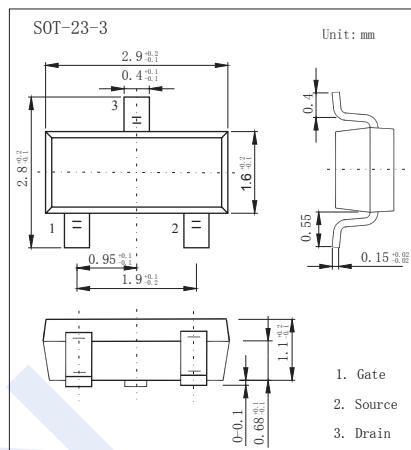
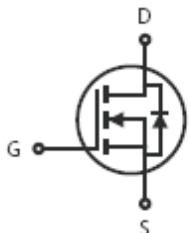


# **N-Channel MOSFET**

## **SI2300-HF (KI2300-HF)**

## ■ Features

- $V_{DS}=20V$ , $R_{DS(ON)}=40m\Omega$  @ $V_{GS}=4.5V$ , $I_D=5.0A$
  - $V_{DS}=20V$ , $R_{DS(ON)}=60m\Omega$  @ $V_{GS}=2.5V$ , $I_D=4.0A$
  - $V_{DS}=20V$  , $R_{DS(ON)}=75m\Omega$  @ $V_{GS}=1.8V$ , $I_D=1.0A$
  - Pb-Free Package May be Available. The G-Suffix Denotes a Pb-Free Lead Finish



#### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	V <sub>Gs</sub>	±10	
Continuous Drain Current T <sub>j</sub> =125 °C	I <sub>D</sub>	3.8	A
Pulsed Drain Current	I <sub>DM</sub>	15	
Power Dissipation	P <sub>D</sub>	1.25	W
Thermal Resistance Junction- to-Ambient	R <sub>thJA</sub>	100	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to 150	

**N-Channel MOSFET****SI2300-HF (KI2300-HF)**

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	V <sub>Gs</sub> =0V,I <sub>D</sub> =250μA	20			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>Ds</sub> =20V,V <sub>Gs</sub> =0V			1	uA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>Gs</sub> =±10V,V <sub>Ds</sub> =0V			±100	nA
Gate Threshold Voltage *	V <sub>Gs(th)</sub>	V <sub>Gs</sub> =V <sub>Ds</sub> ,I <sub>D</sub> =250μA	0.55		1.0	V
Drain- Source on-state Resistance *	R <sub>Ds(ON)</sub>	V <sub>Gs</sub> =4.5V,I <sub>D</sub> =5.0A			40	mΩ
		V <sub>Gs</sub> =2.5V,I <sub>D</sub> =4.0A			60	mΩ
		V <sub>Gs</sub> =1.8V,I <sub>D</sub> =1.0A			75	mΩ
On-State Drain Current *	I <sub>D(ON)</sub>	V <sub>Ds</sub> =5V,V <sub>Gs</sub> =4.5V	18			A
Forward Transconductance *	g <sub>F</sub>	V <sub>Ds</sub> =5V,I <sub>D</sub> =5A	5			S
Input Capacitance	C <sub>iss</sub>	V <sub>Ds</sub> = 15V, V <sub>Gs</sub> = 0V,f = 1.0MHZ		888		pF
Output Capacitance	C <sub>oss</sub>			144		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			115		pF
Turn-On Delay Time	t <sub>D(on)</sub>	V <sub>DD</sub> =10V,I <sub>D</sub> =1A,V <sub>Gs</sub> =4.5V,R <sub>L</sub> =10Ω ,R <sub>GEN</sub> =6Ω		31.8		ns
Rise Time	t <sub>r</sub>			14.5		ns
Turn-Off Delay Time	t <sub>D(off)</sub>			50.3		ns
Fall Time	t <sub>f</sub>			31.9		ns
Total Gate Charge	Q <sub>g</sub>	V <sub>Ds</sub> = 10V, I <sub>D</sub> = 3.5A,V <sub>Gs</sub> = 4.5V		16.8		nC
Gate-S ource Charge	Q <sub>gs</sub>			2.5		nC
Gate-Drain Charge	Q <sub>gd</sub>			5.4		nC
Drain-Source Diode Forward Current *	I <sub>s</sub>				1.25	A
Diode Forward Voltage	V <sub>SD</sub>	V <sub>Gs</sub> =0V,I <sub>s</sub> =1.25A		0.825	1.2	V

\* Pulse Test:Pulse Width≤300 μs,Duty Cycle ≤2%

■ Marking

Marking	00A* F
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